



# PCN - 12 024

Issue Date: March 07 2012

<b>Product Name:</b>	HS CABLE ASSEMBLIES			
	SFP+ CONN. - CAGES			
<b>Product Manager:</b>	Minerva Wang			
<b>Subject:</b>	Product Change Notification			
<b>Distribution:</b>	Global			
<b>Type of Change:</b>	Materials Change			
<b>Change Description:</b>	Plating spec for EMI spring contact change from "1.27um Min.Tin over 1.27um Min.Nickel under-plating" to "1.27um Min.Nickel plating overall" This is an immediate design improvement change.			
<b>Reason for Change:</b>	To change EMI spring contact plating spec in order to meet reflow assembly process criteria. This change will not affect product performance.			
<b>Affected Parts:</b>	10099100-011LF, 10099100-021LF and 10099103-011LF			
<b>Effective Date of Change:</b>	March	08	2012	<i>Special Note:</i> All existing inventory can be used as it is.
<b>Last Time Buy Date:</b>	N/A	N/A	N/A	
<b>Last Disty Return Date:</b>	N/A	N/A	N/A	
<b>Datasheet Attached?</b>	N/A			
<b>Qual/Test Data Attached?</b>	N/A			
<b>Samples Availability Date:</b>	February	20	2012	
<b>Available Alternatives?</b>	N/A			
<b>Questions?</b>	Contact your local FCI Representative, or			
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